PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JIANFEI YANG	04/30/2019
CHAOJUN ZHAO	04/30/2019
XIAOYU REN	04/30/2019
CHANGXU JIANG	04/30/2019
SRINIVASA R. CHAMARTHY	04/30/2019

RECEIVING PARTY DATA

Name:	EMC IP HOLDING COMPANY, LLC
Street Address:	176 SOUTH STREET
City:	HOPKINTON
State/Country:	MASSACHUSETTS
Postal Code:	01748

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16402806

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	113454.00407/114341.01
NAME OF SUBMITTER:	CATHERINE LANGLAIS
SIGNATURE:	/Catherine Langlais/
DATE SIGNED:	05/03/2019

Total Attachments: 7

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PATENT/Joint Assignment Docket No.: 113454.00407/114341.01

ASSIGNMENT

WHEREAS, we, <u>Jianfei Yang, Chaojun Zhao, Xiaoyu Ren, Changxu Jiang, and Srinivasa R. Chamarthy</u> have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled <u>SELF-LEARNING FILE DELEGATION SYSTEM AND METHOD</u> (Application), the specification of which:

[X]	is being executed on even date herewith and is about to be filed in the United States Patent Office;
[]	was filed on as U.S. Application No
[]	was patented under U.S. Patent No on

WHEREAS, EMC IP Holding Company, LLC (hereinafter "ASSIGNEE"), a corporation organized and existing under the laws of the State of Delaware and having a usual place of business at 176 South Street, Hopkinton, Massachusetts 01748 desires to acquire an interest therein in accordance with agreements duly entered into with us;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America. its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. We hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein:

AND, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution,

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reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, we do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives;

AND, we hereby authorize our attorneys, EMC Corporation, to insert here in parenthesis

the application number and filing date of said Application (or foreign counterpart application) to facilitate the recording or other official processing of this Assignment.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals as set forth below:

Date: 20/9/4/30	Jianfei Yang
	Inventor's Signature
Print full name of inventor:	Jianfei Yang
Residence:	Chengdu, Sichuan, CHINA
Citizenship:	China
Mailing Address:	Vanke City Garden, 49A302 Changdu, Sichuan 610000 CHINA
I, Olyde Chea (nan Buddug Suickne Withou	ne of first witness), whose residential address is Rd, Congda, St Chan, China
	ing (name of person signing the assignment), who
is personally known to me, execute the above	assignment.
61 61	¥
Cyde (New	(signature of first witness) (location of witness signature) 2019 (date of signature).
Signed at Claydu, Schua, O.	ka (location of witness signature)
on this day, Apr. 30	2019 (date of signature).
;••	₩
	# # # # # # # # # # # # # # # # # # #
1,	ne of second witness), whose residential address is
	chengolu, Si Chuan, China
	ng (name of person signing the assignment), who
is personally known to me, execute the above	assignment.
18° 1	
	(signature of second witness)
	1/n.m. (location of witness signature)
on this day, App., 3000,	2019 (date of signature).

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Date: 701 . 4. 30	Chaopin Zhao
	Inventor's Signature
Print full name of inventor	Chaojun Zhao
Residence	Chengdu, Sichuan, CHINA
Citizenship	
Mailing Address	Fu Hao Shi Dai #22-1-7, Ying Chun Road 3-158 Shuangliu Chengdu, Sichuan 610000 CHINA
	one of first witness), whose residential address is 1004, Qing Bo Road, Chengolu, Sichuan, China
	Than (name of person signing the assignment),
who is personally known to me, execute the al	bove assignment.
S	
그 그 그 그 그 그 그 그 그 그 그 그 그 그 그 그 그 그 그	signature of first witness)
Signed at Cheny du , Sichuan Ch	(location of witness signature)
on this day, Apr. 30,	2019 (date of signature).
· · · · · · · · · · · · · · · · · · ·	
I, <u>Non, Usde</u> (nam Brestdana, C. dan 10), Tan	e of second witness), whose residential address is kd, Clenzdu, Si Cluan, Claca
was personally present and did see Chumina 2	<u>Than</u> (name of person signing the assignment),
who is personally known to me, execute the al	
Clea, Clyde	signature of second witness)
Signed at Chapda, Si Cluas (
	2019 (date of signature).

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Date: 20/9/4/30	10 1976 len
	Inventor's Signature
Print full name of inventor	Xiaoyu Ren
Residence	Chengdu, Sichuan, CHINA
Citizenship	China
Mailing Address	Xiangnian Square Building T1, No. 88 Jitai Road, Tianfu Ave. Chengdu, Sichuan 611830 CHINA
I, <u>Zhang Konig</u> Named Town, Zhirne shene	(name of first witness), whose residential address is Rd. Chan dw. Si Chuan Chrima
	ovn Ren (name of person signing the assignment), who is
personally known to me, execute the ab	end the state of t
Zhang, Youf	(signature of first witness)
Signed at Cheedle, Sichum, Ch	ina (location of witness signature)
on this day, Apr 30	
# *** 	*
I, Pun Xiao	(name of second witness), whose residential address is
	gdu, Sichwan, China
was personally present and did see Xiai	ovu Ren (name of person signing the assignment), who is
personally known to me, execute the ab-	ove assignment.
Pan Xi ao	(signature of second witness)
Signed at Chengolu, Sichwan	China (location of witness signature)
on this day,	, 2019 (date of signature).

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Date: 2019/4/30	Changeu Jiang
	Inventor's Signature
Print full name of inventor	Changxu Jiang
Residence	Chengdu, Sichuan, CHINA
	3
Citizenship	<u>China</u>
Mailing Address	Shu Jun You Yi Cheng #116-1
	Hua Fu Avenue 518 Chengdu, Sichuan 625008
	CHINA
I Zhant Yang (nam	e of first witness), whose residential address is
Noncol Town 2 hours Shan DA	chang dur. Si chuan, China
	liang (name of person signing the assignment),
who is personally known to me, execute the at	2000
	ore assignment.
Zhang Yang	signature of first witness)
Signed at Changdu Sichum Chi	(location of witness signature) 2019 (date of signature).
on this day, Apr. 10	2019 (date of signature).
	and or organization.
	-4 ⁴
i, <u>Pan Xiao</u> (nam	e of second witness), whose residential address is
	Sichus China
was personally present and did see Changxu J	
who is personally known to me, execute the ab	populari
1	0.10 Moong
Pan Xiau (signature of second witness)
X	in a (location of witness signature)
	2019 (date of signature).
······································	2012 Quale of arguatures.

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Date: \$0\frac{64}{2019}	Favor's Signature
Print full name of inventor	Srinivasa R. Chamarthy
Residence	Bangalore, Karnataka INDIA
Citizenship	2noia
Mailing Address	MJ Azhalia, near Notre Damme School Hoskur PO, Choodasndra Bangalore, Karnataka 560035 INDIA
I, VINOD GOMATAM (nam NM 501, SHRIRAM SORAB	ne of first witness), whose residential address is HI, NALLASANDRA BANGALORE
was personally present and did see Srinivasa	enginerani (1700) 1700 m. promitor i di distributationi di
assignment), who is personally known to me,	execute the above assignment.
and GK.	(signature of first witness) 2 (A) (location of witness signature)
Signed at <u>BANGALORE</u> INC	(location of witness signature)
on this day, 20th APR,	2019 (date of signature).
I, Amod Sutavane (nam BO, BLOCK-2, SAMHHTA CART	ne of second witness), whose residential address is
was personally present and did sec <u>Srinivasa</u>)	R. Chamarthy (name of person signing the
assignment), who is personally known to me, o	execute the above assignment. (signature of second witness)
	(location of witness signature)
on this day, <u>영어/8</u> 명이 있다.	

PATENT REEL: 049074 FRAME: 0727

RECORDED: 05/03/2019